

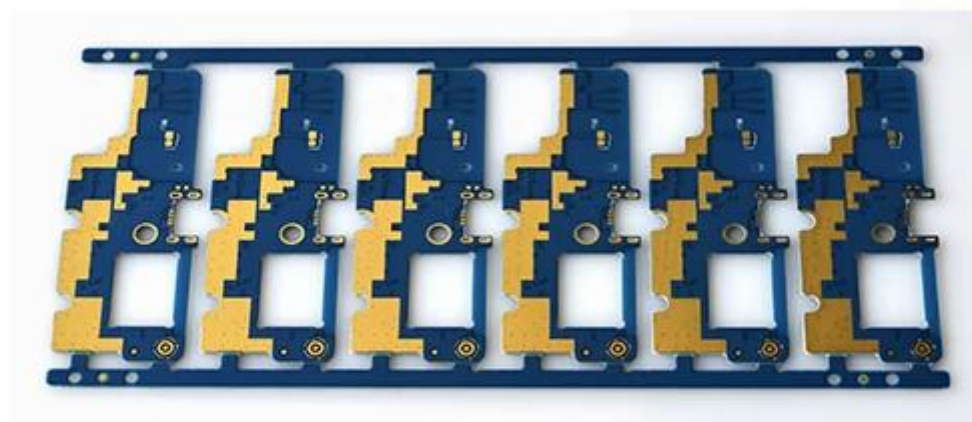
Benvenuti in O-Leader

Gli o-leader si impegna ad essere il tuo partner Solution One Stop nella catena di approvvigionamento EMS, incluso il design PCB, la fabbricazione di PCB e il PCB Assembly (PCBA). Forniamo alcune delle più avanzate tecnologie PCB, inclusi PCB HDI, PCB multistrato, PCB flessibili rigidi . Possiamo supportare dal prototipo di rotazione rapida a media e produzione di massa.

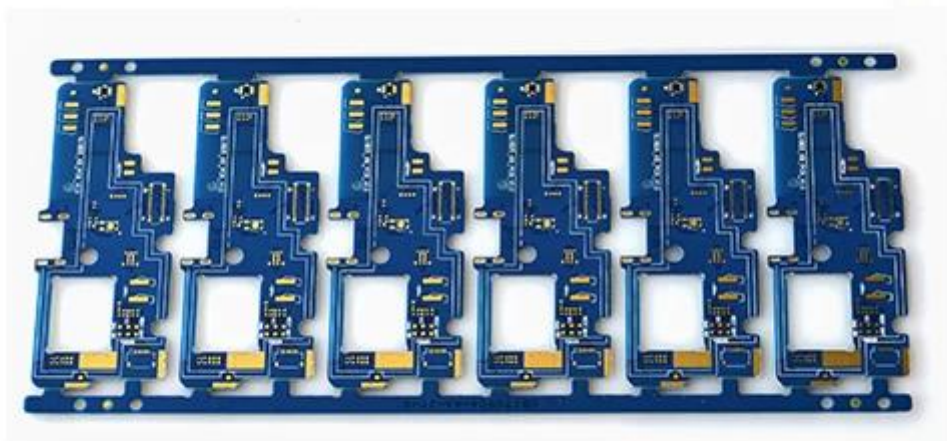
In generale, i nostri clienti globali sono molto impressionati dai nostri servizi: risposta rapida, prezzo competitivo e impegno di qualità. Provare un servizio tecnico più prezioso e una soluzione generale è il modo in cui O-guida in avanti.

Guardando al futuro, O-leader si concentrerà sull'innovazione e lo sviluppo della tecnologia di produzione dell'elettronica come sempre e rendono sempre sforzi persistenti sul servizio PCB e PCBA one-stop per fornire servizi di prima classe e creare più valore per i nostri clienti.

Si prega di fare clic su questi per ulteriori informazioni: **[Produttore della scheda PCB OEM](#)**



www.o-leading.com



www.o-leading.com

Luogo d'origine	Guangdong, Cina (continente)	Marchio	O-leader.
Materiale di base	FR-4 ,, alluminio, rogers, rame pesante, ecc.	Spessore di rame	0,5oz-5 once.
Min. Dimensione del buco	0,2 mm.	Min. Larghezza della linea	0,2 mm.
Finitura superficiale	Admersion oro / stagno / argento, osp, hasl senza piombo	Min. Interlinea	0,2 mm.
applicabile a	LED, cellulare, condizionatori d'aria, lavatrici	carattere	PCB di controllo industriale
certificati	ISO9001, UL, RoHS, SGS	Q / CTN.	Requisito del cliente
peso	0,01kg -5kg.	MOQ.	10 pezzi
colore	blu, rosso, verde, nero.yellow	Spessore del bordo	0,1-5mm.
Numero di modello	Produttore PCBA assembly PCB	prezzo	\$ 0,1- \$ 10
Desigh Tipo.	Requisito del cliente	dimensione	0,01 m3-10m3.

La nostra squadra



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Certificazioni





Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ

Date of Sample Received : 22 Mar 2019

Testing Period : 22 Mar 2019 - 30 Mar 2019

Test Requested : Selected test(s) as requested by client.

Test Method : Please refer to next page(s).

Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina Fan
Approved Signatory



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Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

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Test Results :

Test Part Description :

Specimen No.	SGS Sample ID	Description
SN1	SZX19-005304.001	Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
- (2) MDL = Method Detection Limit
- (3) ND = Not Detected (< MDL)
- (4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test item(s)	Limit	Unit	MDL	Q/Z
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND



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ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Max		Max		Meets UL796 Class	C T DSR	
	Min	Min			Area	Solder	Oper	Flame			
	mm(in)	mm(in)			Diam	Limits	Temp	Temp			
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲ *
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All *

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Confezione e consegna

Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Capacità di processo

Capacità di produzione PCB.

Conteggio del livello: 1Layer-32layer

Spessore di rame finito: 1/3 once-12oz

Min Larghezza linea / spaziatura interna: 3.0mil / 3.0mil

Min Larghezza linea / spaziatura esterna: 4.0mil / 4.0mil

Rapporto massimo: 10: 1

Spessore del bordo: 0,2 mm-5.0mm

Dimensione del pannello massimo (pollici): 635 * 1500mm

Dimensione minima forata forata: 4mil

Tolleranza del foro piegata: +/- 3mil

BIIND / Vias sepolti (Tipi AII): Sì

Via Riempimento (conduttivo, non-conduttivo): sì

Materiale base: FR-4, FR-4High TG. MATERIALE GRATUITO FREE, ROGERS, BASE DI ALLUMINIO,Poliimmide, Rame pesante

Finiture superficiali: hasl, osp, enig, hal-If, Immerion argento,Tin di LMMER, dita d'oro, inchiostro del carbonio

Capacità di produzione SMT.

Materiale PCB: FR-4, CEM-1, CEM-3, scheda a base di alluminio

MAX PCB Dimensione: 510x460mm

MIN Dimensioni PCB: 50x50mm

Spessore PCB: 0,5 mm-4.5mm

Spessore del bordo: 0,5-4mm

Min Componenti Dimensioni: 0201

Componente di dimensioni del chip standard: 0603 e più grande

Componente Altezza massima: 15mm

Min Pitch: 0.3mm

Min BGA Ball Pitch: 0.4mm

Precisione del posizionamento: +/- 0,03mm